



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

KAAF-5060PBESEEVGC

BLUE / HYPER ORANGE
GREEN

Features

- CHIPS CAN BE CONTROLLED SEPARATELY.
- SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- AVAILABLE ON TAPE AND REEL.
- PACKAGE: 500PCS / REEL.
- RoHS COMPLIANT.

Description

The Blue source color devices are made with InGaN on SiC Light Emitting Diode.

The Hyper Orange source color devices are made with DH InGaAlP on GaAs substrate Light Emitting Diode.

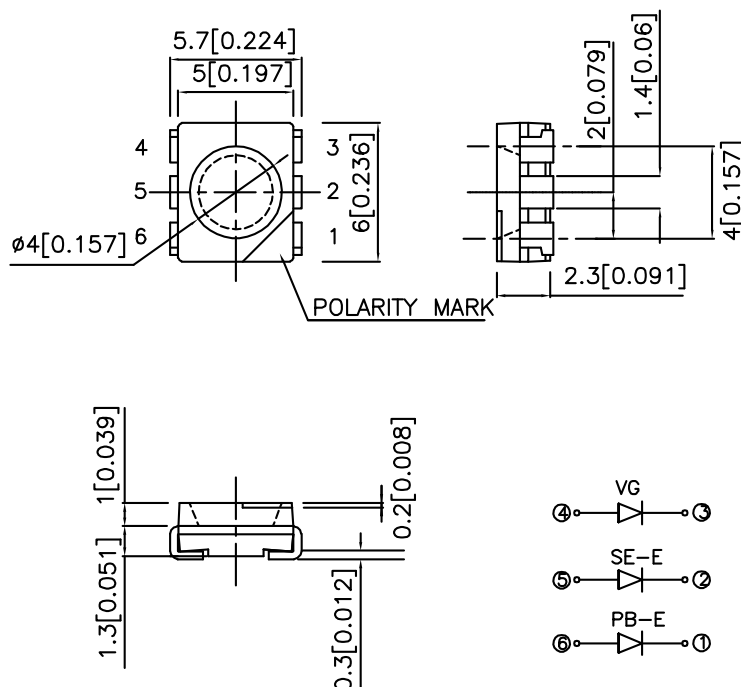
The Green source color devices are made with InGaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ unless otherwise noted.
3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @30mA* 50 mA		Viewing Angle
			Min.	Typ.	2 θ 1/2
KAAF-5060PBESEEVGC	BLUE (InGaN)	WATER CLEAR	110	250	100°
	HYPER ORANGE(InGaAlP)		*650	*1000	
	GREEN (InGaN)		180	350	

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. * Luminous intensity with asterisk is measured at 50mA.

Electrical / Optical Characteristics at TA=25°C

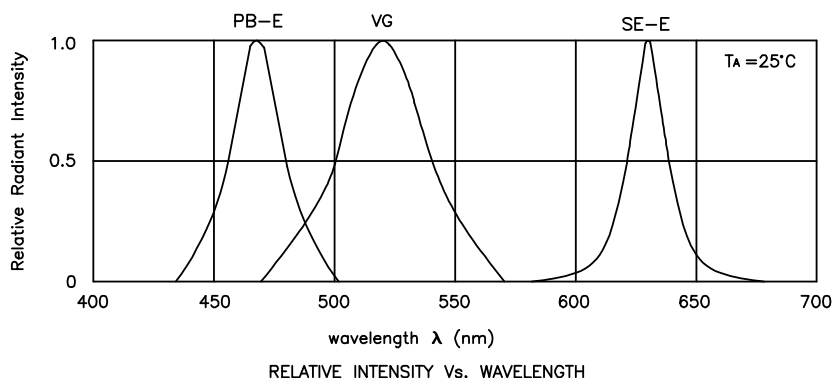
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Blue Hyper Orange Green	465 630 520		nm	IF=20mA
λ_D	Dominant Wavelength	Blue Hyper Orange Green	470 621 525		nm	IF=20mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Blue Hyper Orange Green	25 20 38		nm	IF=20mA
C	Capacitance	Blue Hyper Orange Green	110 25 45		pF	VF=0V;f=1MHz
VF	Forward Voltage	Blue Hyper Orange Green	3.7 2.0 3.5	4.3 2.5 4.5	V	IF=20mA
IR	Reverse Current	All		10	uA	VR = 5V

Absolute Maximum Ratings at TA=25°C

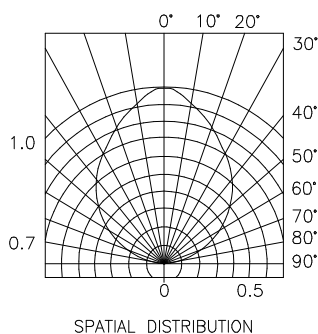
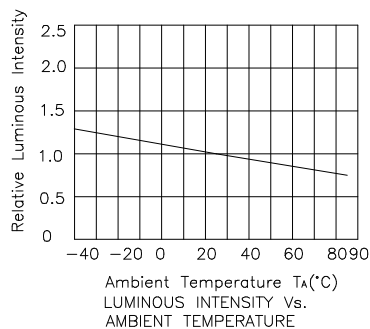
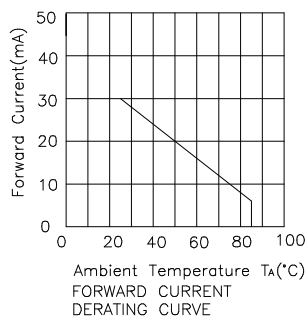
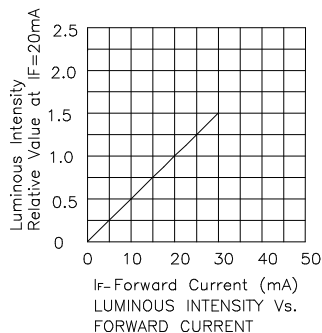
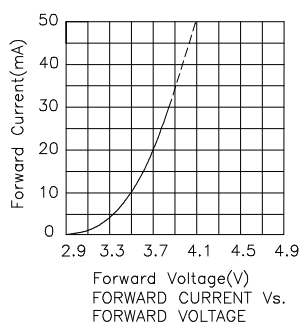
Parameter	Blue	Hyper Orange	Green	Units
Power dissipation [2]	350			mW
DC Forward Current	30	50	30	mA
Peak Forward Current [1]	160	195	150	mA
Reverse Voltage	5			V
Operating / Storage Temperature	-40°C To +85°C			

Notes:

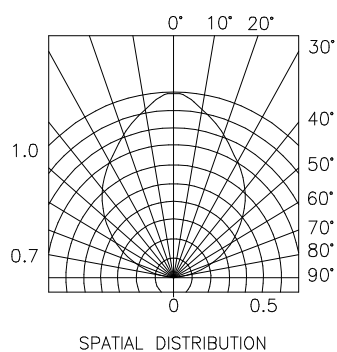
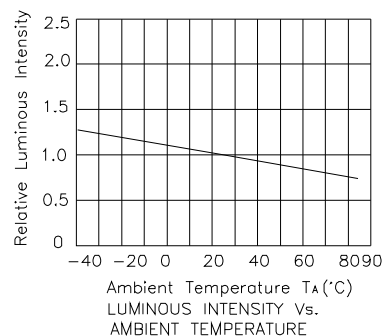
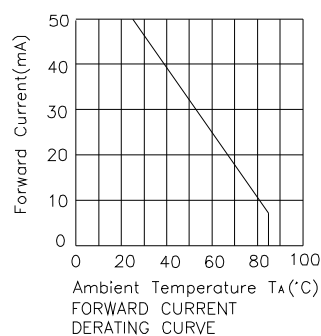
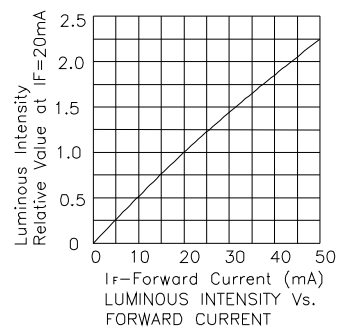
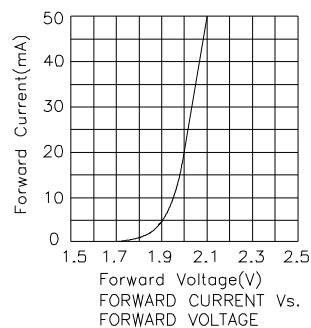
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. Within 350mW at all chips are lightened.



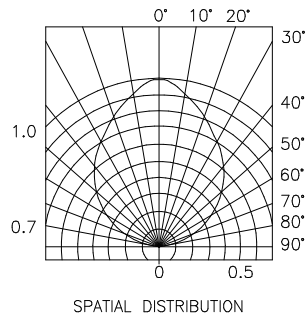
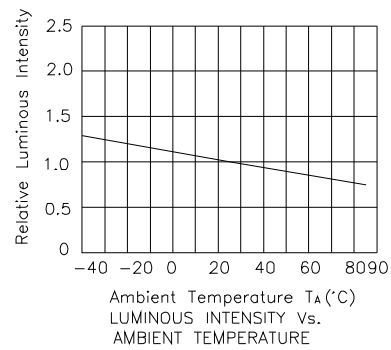
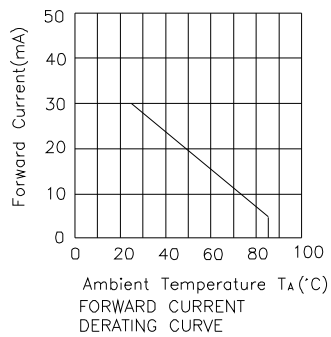
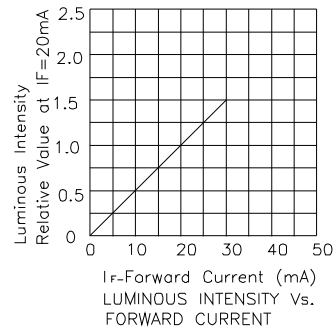
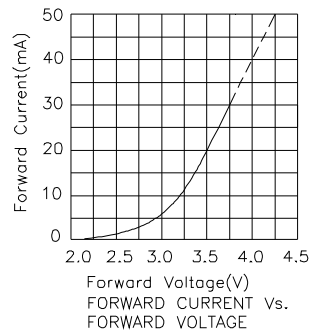
KAAF-5060PBESEEVGC
Blue



Hyper Orange

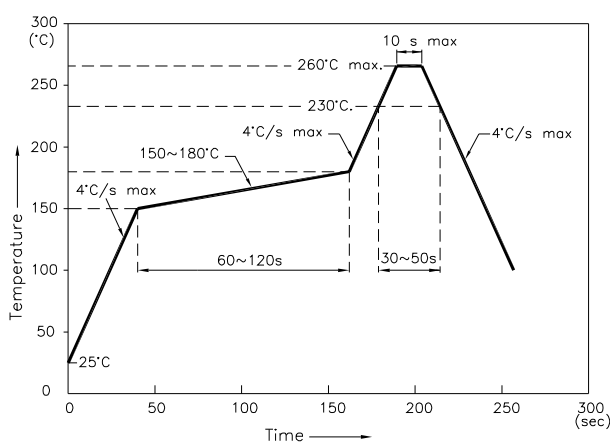


Green



KAAF-5060PBESEEVGC

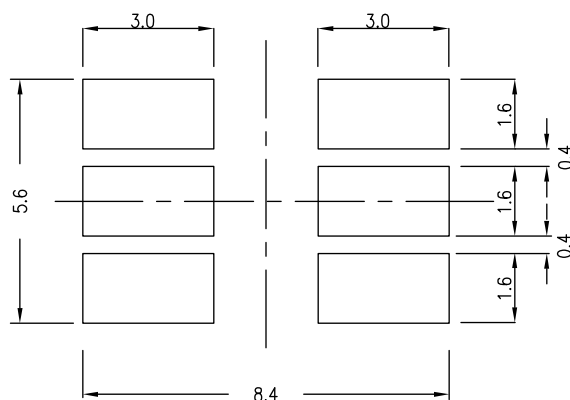
Reflow Soldering Profile For Lead-free SMT Process.



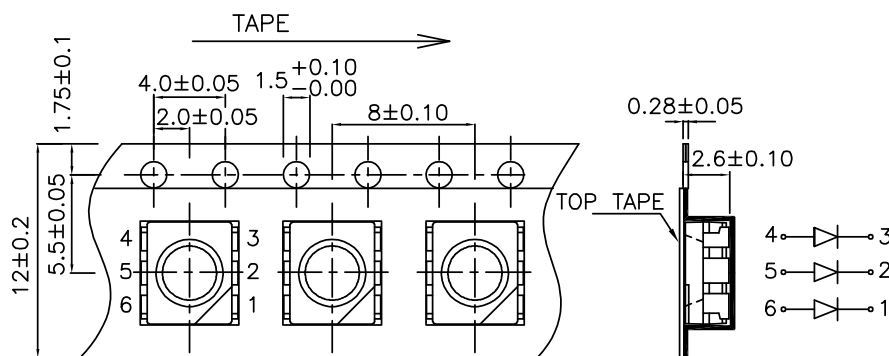
NOTES:

1. We recommend the reflow temperature $245^{\circ}\text{C} (+/-5^{\circ}\text{C})$. The maximum soldering temperature should be limited to 260°C .
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm)



Tape Specifications (Units : mm)



If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: $\pm 1\text{nm}$
2. Luminous Intensity: $\pm 15\%$
3. Forward Voltage: $\pm 0.1\text{V}$

Note: Accuracy may depend on the sorting parameters.